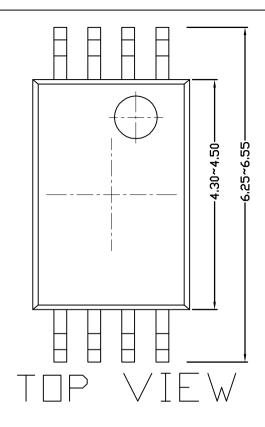
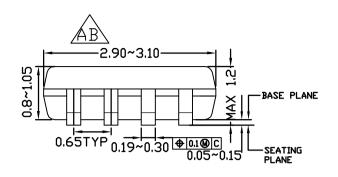
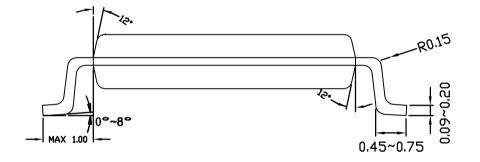
DRAWING REVISION HISTORY

REV. NO.	REASON FOR REV.	DATE	Prepared	
AA	New Release	2019.11.01	Que YJ	
AB	CHANGE WIDTH FROM 4.9~5.1 TO 2.9~3.1	2019.12.20	Que YJ	

_											
		NAME	DEPARTMENT	Anst 华润安盛							
	ORIGINATOR	Que YJ	R&D	<u> </u>							
	REVIEWER	Huo Y	R&D	TOLERANCES ARE:		ied Ter	TITLE TSSOP8 PKG OUTLINE				
	REVIEWER	Xu G	A-PE					DRAWING NO. S-PED-PKTS008-00-02		1 °	REV.
	REVIEWER			X,XXX ±0.050 PROJECTION	SCALE	SIZE	S-PED-P	N/A		AB	
	APPROVER	Wang JX	ATC	₽ ♦		A4	Reference Code.	N/A	1	F 2	







NOTES:

- 1) LEAD FRAME: C7025(THICKNESS:0.127MM)
- 2) LEAD FINISH: SOLDER PLATED
- 3) BOTH PACKAGE LENGTH AND WIDTH DO NOT INCLUDE FLASH.
- 4) FORMED LEAD SHALL BE PLANAR WITH RESPECT TRO ONE ANOTHER WITHIN 0.10(0.004)
- 5) CONTROLLING DIMENSION: MM.
- 6)UNREMOVED FLASH BETWEEN LEADS&PACKAGE END FLASH SHALL NOT EXCEED 0.15MM FROM BOTTOM BODY PER SIDE.
- 7)EDP PACKAGE:EXPOSED PAD SIZE P1&P2 ARE VARIATIONS DEPENDING ON DEVICE FUNCTION(DIE PADDLE SIZE).



Doc-00014-AC

ELECTRONIC VERSIONS ARE UNCONTROLLED EXCEPT WHEN ACCESSED DIRECTLY FROM THE DOCUMENT REPC